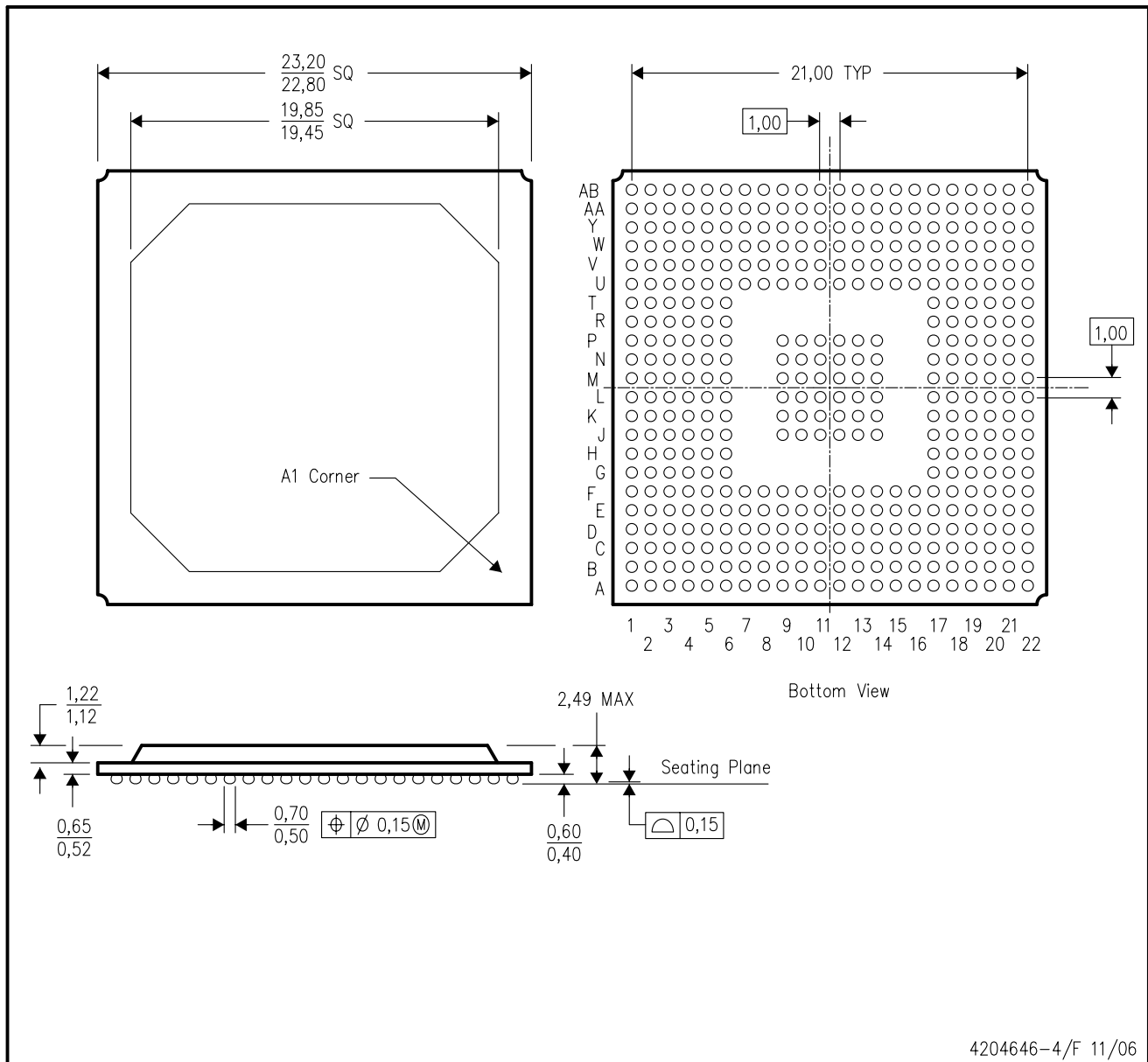


GDW (S-PBGA-N420)

PLASTIC BALL GRID ARRAY



4204646-4/F 11/06

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MO-151
 - D. Thermally enhanced plastic package

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